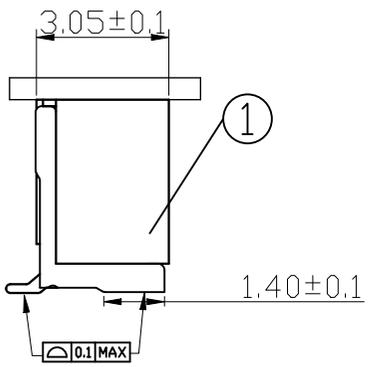
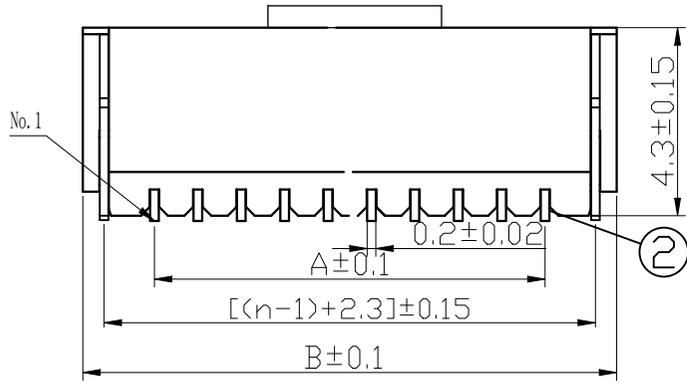
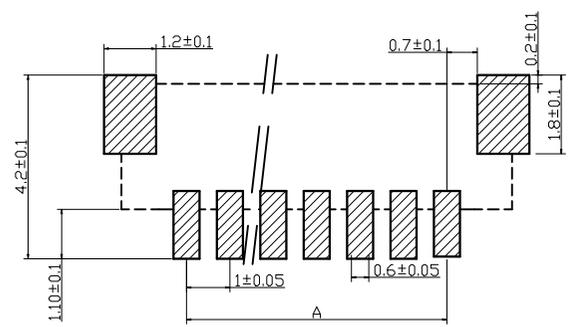
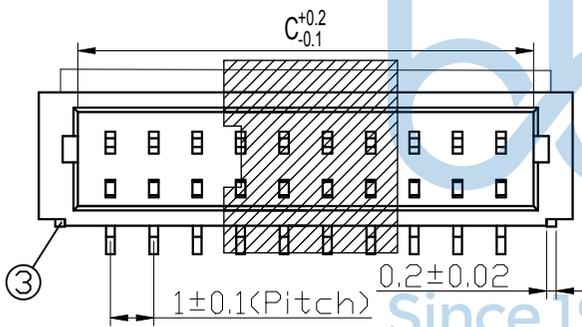
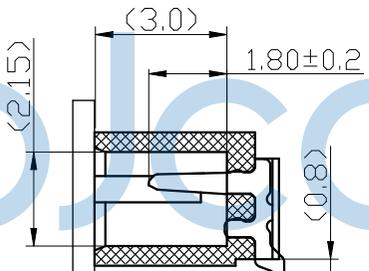


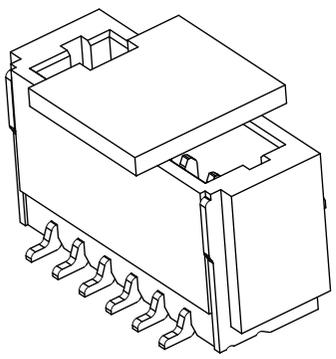
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



- 技术指标:
- 1、塑件表面应光洁、无毛刺、明显收缩、缺陷、裂纹等现象;
  - 2、温度范围: -25° C~+85° C;
  - 3、额定电压: 150V, AC, DC(等效);
  - 4、接触电阻: ≤0.02Ω;
  - 5、绝缘电阻: ≥100MΩ;
  - 6、耐压: 500V, AC/minute.



1.0LT-mP PCB寸法  
PCB Layout



孔位 poles	A	B	C
2	1	4.3	2.4
3	2	5.3	3.4
4	3	6.3	4.4
5	4	7.3	5.4
6	5	8.3	6.4
7	6	9.3	7.4
8	7	10.3	8.4
9	8	11.3	9.4
10	9	12.3	10.4
11	10	13.3	11.4
12	11	14.3	12.4
13	12	15.3	13.4
14	13	16.3	14.4
15	14	17.3	15.4
16	15	18.3	16.4
17	16	19.3	17.4
18	17	20.3	18.4
19	18	21.3	19.4
20	19	22.3	20.4

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co., Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION. PDWG.NO: 0510-1

**深圳市步步精科技有限公司**

NAME: 针座 1.0-14P 立贴 加盖 米黄色

APPD. JM\_Zheng

CHKD. LYX

DR. TSP

PJ. NO.: 123-244-140001-Y3G

SIZE: A4 DRW NO.:

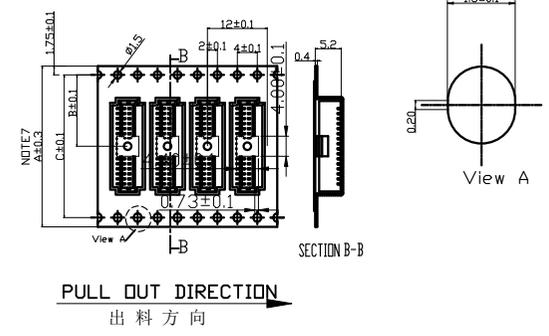
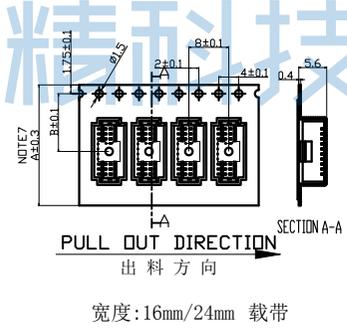
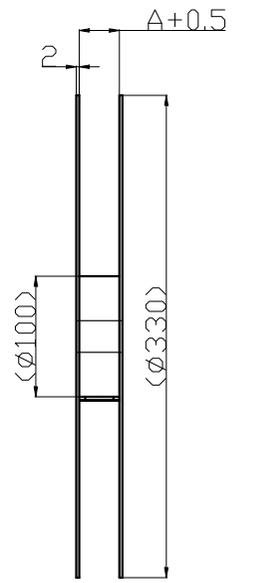
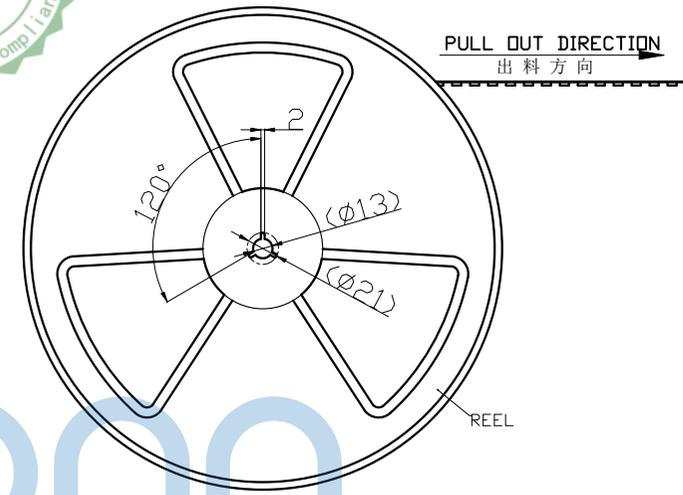
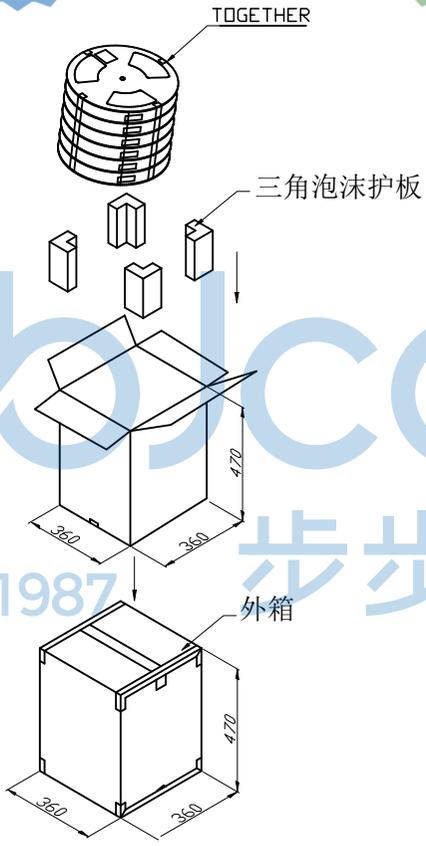
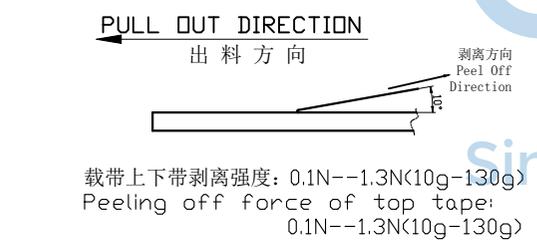
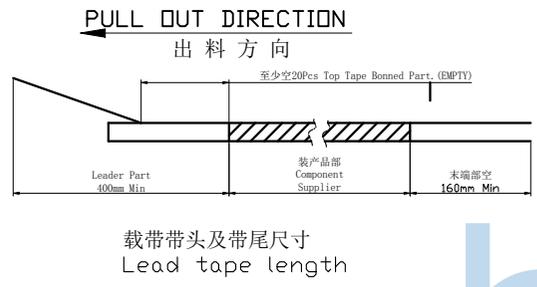
FINISH: SEE NOTES MAT'L.: SEE NOTES

SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2

序号	名称	材料	数量	附注
3	焊片 Fitting Nail	磷青铜 Phosphor Bronze	2	电镀(锡): 整个表面镀底镍30u"MIN,再镀锡 80u"MIN.
2	端子 Contact	磷青铜 Phosphor Bronze	n*1	电镀(锡): 整个表面镀底镍30u"MIN,再镀锡 80u"MIN.
	基座 Wafer	LCP(U94V-0)	1	本色



REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



Note:

- Sprocket holes pitch cumulative tolerance  $\pm 0.1$ . (Accumulative Pitch  $\pm 0.2$ )
- Carrier camber is within 1mm in 100mm.
- All dimensions meet EIA-481-D requirements.
- Thick ness:  $0.4 \pm 0.1$ mm.
- Material of top fape: PET, PE, PEF
- Material of carrier fape: Poystyrene
- For tape width (dimension A) 16mm and 24mm a pilot hole is provided on one side. For tape width (dimension A) 32mm and 44mm pilot holes are provided on both sides.

芯数 Pin (n)	尺寸 Size		
	A	B	C
2-6	16.0	7.5	---
7-14	24.0	11.5	---
15-16	32.0	14.2	28.4

1.0WT-mP				
REEL WIDTH	16	24	32	44
PCS/REEL	1500			
CTN. SIZE	360*360*470			

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co., Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION. PDWG.NO: 0510-1

**深圳市步步精科技有限公司**

NAME: 针座 1.0-14P 立贴 加盖 米黄色

PJ. NO.: 123-244-140001-Y3G

SIZE: A4 DRW NO.:

FINISH: SEE NOTES MAT'L.: SEE NOTES

SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/2

APPD. JM\_Zheng

CHKD. LYX

DR. TSP

尺寸公差: .X:  $\pm 0.38$  .XX:  $\pm 0.25$  .XXX:  $\pm 0.13$ ; X':  $\pm 3'$  X'':  $\pm 2'$  X''':  $\pm 1'$